



Product Change Notification

Change Notification#: 116561 - 01

Change Title: Intel® Core™ and Intel® Xeon® Processors
PCN 116561-01, Manufacturing Site,
Adding Vietnam as an additional site for
Test & Finish, Reason for Revision: Enabling
Manufacturing Site Vietnam to perform partial
and full flow manufacturing and updating
Products Affected table

Date of Publication: May 31, 2019

Key Characteristics of the Change:

Manufacturing Site

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	December 14, 2018
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Description of Change to the Customer:

Reason for Revision: Enabling Manufacturing Site Vietnam to perform partial and full flow manufacturing and updating Products Affected table

Intel has certified the Vietnam Manufacturing Site (VNAT) to perform full flow manufacturing (Assembly, Test, and Finish) as well as partial manufacturing among the two qualified sites for Assembly, Test, and Finish. Assembly, Test and Finish will continue to be done in PGAT (Malaysia) as well.

Both the Malaysia Manufacturing Site and the Vietnam Manufacturing Sites have been certified equivalent (form, fit, function, and reliability) for the affected products and technologies of this change

With the possibility of full flow, or partial flow of material now coming from Vietnam, the value for the Country of Origin, on box labels, will now show either site (depending on the site which performed Assembly).

(P) CUST PROD: (1B) BOX: RLP00008

(V) SUPPLIER: 04195 INTEL

(1P) IPN: INTEL PRODUCT NAMEXX

(S) SPEC: S 1234 (30P) MM#: 123456

(1T) LOT: FPO NUMBER (Q) QTY: 12345 (9D) DATE: YYWW

(1T) LOT: (Q) QTY: (9D) DATE:

RoHS COMPLIANT, e1

MAX REFLOW 260 °C
TEMP
LEVEL 3 HOURS 168
BAG SEAL DATE 09DEC05

ASSEMBLED IN MALAYSIA

(P) CUST PROD: (1B) BOX: RLX00037

(V) SUPPLIER: 04195 INTEL

(1P) IPN: INTEL PRODUCT NAMEXX

(S) SPEC: S 1234 (30P) MM#: 123456

(1T) LOT: FPO NUMBER (Q) QTY: 12345 (9D) DATE: YYWW

(1T) LOT: (Q) QTY: (9D) DATE:

RoHS COMPLIANT, e1

MAX REFLOW 260 °C
TEMP
LEVEL 3 HOURS 168
BAG SEAL DATE 03JUN14

ASSEMBLED IN VIETNAM

Vietnam's manufacturing activity today:

Prior Scenarios	Present/To-Be Scenarios
Assembly, Test and Finish Process certified in Malaysia Mfg site (PGAT)	Assembly, Test and Finish Process certified in Malaysia Mfg site (PGAT)
Partial Assembly (PGAT) with Test and Finish Process certified in VNAT	Partial Assembly (PGAT) with Test and Finish Process certified in VNAT
	Full Flow (Assembly, Test and Finish) Process certified in VNAT)

Customer Impact of Change and Recommended Action:

Customers should notify their receiving department of the additional country involved in the manufacturing of the products impacted. It is possible that Customers may receive finished materials manufactured entirely at one of the two qualified sites or split between the two sites to accomplish Assembly, Test and Finish.

Customers may contact their Intel Field Sales Representative or the contacts listed on the last page of this Product Change Notification appropriate to your geo with questions.

Products Affected / Intel Ordering Codes:

Marketing Name	Platform	Product Code	S-Spec	MM#
Intel® Core™ i9-9900K Processor	DESKTOP	CM8068403873914	S RELS	983354
Intel® Core™ i7-9700K Processor	DESKTOP	CM8068403874212	S RELT	983355
Intel® Core™ i5-9600K Processor	DESKTOP	CM8068403874404	S RELU	983356
Intel® Xeon® E-2278G Processor	WORKSTATION	CM8068404225303	S RFB2	999CD4
Intel® Xeon® E-2288G Processor	WORKSTATION	CM8068404224102	S RFB3	999CD6
Intel® Core™ i5-9400 Processor	DESKTOP	CM8068403875505	S RG0Y	999H28
Intel® Core™ i5-9400F Processor	DESKTOP	CM8068403875510	S RG0Z	999H29
Intel® Core™ i5-9500F Processor	DESKTOP	CM8068403875414	S RG10	999H2A
Intel® Core™ i5-9600K Processor	DESKTOP	CM8068403874405	S RG11	999H2C
Intel® Core™ i5-9600KF Processor	DESKTOP	CM8068403874410	S RG12	999H2D
Intel® Core™ i7-9700 Processor	DESKTOP	CM8068403874521	S RG13	999H2F
Intel® Core™ i7-9700F Processor	DESKTOP	CM8068403874523	S RG14	999H2G
Intel® Core™ i7-9700K Processor	DESKTOP	CM8068403874215	S RG15	999H2H
Intel® Core™ i7-9700KF Processor	DESKTOP	CM8068403874220	S RG16	999H2J
Intel® Core™ i7-9700T Processor	DESKTOP	CM8068403874912	S RG17	999H2L
Intel® Core™ i9-9900 Processor	DESKTOP	CM8068403874032	S RG18	999H39
Intel® Core™ i9-9900K Processor	DESKTOP	CM8068403873925	S RG19	999H3A
Intel® Core™ i9-9900KF Processor	DESKTOP	CM8068403873928	S RG1A	999H3C
Intel® Core™ i9-9900T Processor	DESKTOP	CM8068403874122	S RG1B	999H3D
Intel® Core™ i5-9400 Processor	DESKTOP	CM8068403875504	S RELV	983357
Intel® Core™ i9-9900KF Processor	DESKTOP	CM8068403873927	S RFAA	999C3J
Intel® Core™ i7-9700KF Processor	DESKTOP	CM8068403874219	S RFAC	999C3L
Intel® Core™ i5-9600KF Processor	DESKTOP	CM8068403874409	S RFAD	999C3M
Intel® Core™ i5-9400F Processor	DESKTOP	CM8068403875509	S RFAH	999C3T

PCN Revision History:

Date of Revision:

October 19, 2018

May 31, 2019

Revision Number:

00

01

Reason:

Originally Published PCN
 Enabling Manufacturing Site
 Vietnam to perform partial and full
 flow manufacturing and updating
 Products Affected table



Product Change Notification

116561 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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